

## **Features**

Extremely Fast Switching Speed Low Forward Voltage Pb-Free Package is Available



## **Package Marking and Ordering Information**

Product ID	Product ID Pack		Qty(PCS)	
HBAT54XV2T1G	AT54XV2T1G SOD-523		3000	



Maxmim Ratings (Ta=25 unless otherwise noted)

Parameter	Symbol	Limits	Unit	
DC Reverse voltage	$V_R$	30	V	
Continuous forward current	I <sub>F</sub>	200	mA	
Peak forward surge current	I <sub>FSM</sub>	600	mA	
Total power dissipation	P <sub>tot</sub>	200	mW	
Total resistance junction to ambient	$R_{\theta JA}$	635	°C/W	
Junction temperature	Tj	150	$^{\circ}$	
Storage temperature	T <sub>stg</sub>	-55-150	$^{\circ}$	

Electrcal Charcteristics (Ta=25 unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Reverse breakdown voltage	V <sub>(BR)R</sub>	30			V	I <sub>R</sub> =100μA
			0.22	0.24		I <sub>F</sub> =0.1mA
			0.41	0.5		I <sub>F</sub> =30mA
Forward voltage	$V_{F}$		0.52	0.8	V	I <sub>F</sub> =100mA
			0.29	0.32		I <sub>F</sub> =1.0mA
			0.35	0.40		I <sub>F</sub> =10mA
Reverse current	I <sub>R</sub>		0.5	2.0	μΑ	V <sub>R</sub> =25V
Diode capacitance	C <sub>d</sub>		7.6	10	pF	V <sub>R</sub> =1V,f=1MHz
Reverse recovery time	t <sub>rr</sub>			5	ns	I <sub>F</sub> =I <sub>R</sub> =10mA



# **Typical Characteristics**

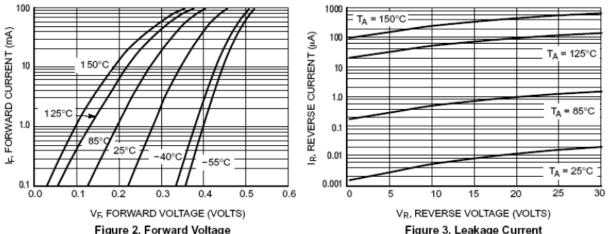


Figure 2. Forward Voltage

Figure 3. Leakage Current

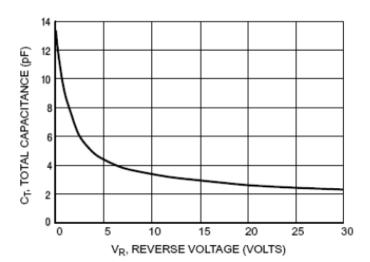
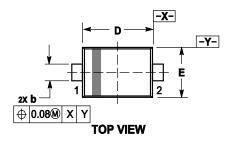
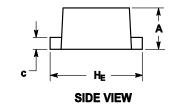


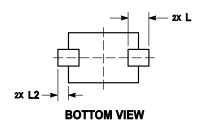
Figure 4. Total Capacitance



## **OUTLINE AND DIMENSIONS**







#### Notes:

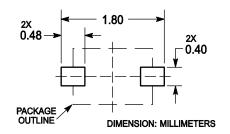
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD

### THICKNESS OF BASE MATERIAL.

4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.50	0.60	0.70	0.020	0.024	0.028
b	0.25	0.30	0.35	0.010	0.012	0.014
С	0.07	0.14	0.20	0.003	0.006	0.008
D	1.10	1.20	1.30	0.043	0.047	0.051
Е	0.70	0.80	0.90	0.028	0.031	0.035
H <sub>E</sub>	1.50	1.60	1.70	0.059	0.063	0.067
L	0.30 REF		0.012 REF			
$L_2$	0.15	0.20	0.25	0.006	0.008	0.010

## **SOLDERING FOOTPRINT**





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